



- NOTES
1. ALL EXPOSED METAL AND METALLIZED AREA SHALL BE GOLD PLATED 60 MICRO INCHES THK. OVER NICKEL PLATED UNLESS OTHERWISE SPECIFIED PURCHASE ORDER.
 2. FLATNESS METALLIZED PADS ONLY.
 3. SEAL AREA AND DIE ATTACH AREA SHALL BE ISOLATED FROM ANY LEADS. (ZERO GROUND)

NAME 68 LEAD J BEND CHIP CARRIER (460 SQ CAV)				TOLERANCES <small>UNLESS OTHERWISE SPECIFIED</small> $\pm .005$		DRAWN <i>T-Tanaka</i>	CHECKED <i>Tanaka</i>
SCALE $7/1$		MATERIAL CERAMIC KYOCERA 4-4-70		APPROVED <i>Tanaka</i>		DATE 1-13-72	
CHANGE				KYOCERA CORPORATION		KYOTO JAPAN	

$S=0$
 $D=C$
 V50-58JE